



SPP3095

P-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPP3095 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application, such as DC/DC converter and Desktop computer power management.

The package is universally preferred for commercial industrial surface mount applications

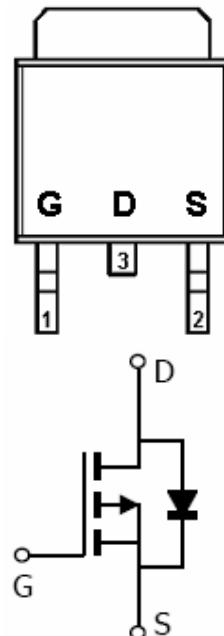
APPLICATIONS

- Power Management in Desktop Computer
- DC/DC Converter
- LCD Display inverter

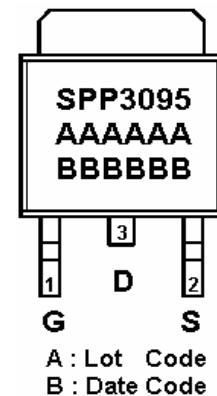
FEATURES

- ◆ -30V/- 8A,R_{DS(ON)}=100mΩ@V_{GS}=- 10V
- ◆ -30V/- 6A,R_{DS(ON)}=150mΩ@V_{GS}=-4.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ TO-252-2L package design

PIN CONFIGURATION (TO-252-2L)



PART MARKING





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PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPP3095T252RG	TO-252-2L	SPP3095
SPP3095T252RGB	TO-252-2L	SPP3095

- ※ Week Code : A ~ Z(1 ~ 26) ; a ~ z(27 ~ 52)
- ※ SPP3095T252RG : Tape Reel ; Pb – Free
- ※ SPP3095T252RGB : Tape Reel ; Pb – Free ; Halogen - Free

ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit	
Drain-Source Voltage	V _{DSS}	-30	V	
Gate –Source Voltage	V _{GSS}	±20	V	
Continuous Drain Current(T _J =150°C)	T _A =25°C	ID	-12	A
	T _A =70°C		-8	
Pulsed Drain Current	I _{DM}	-20	A	
Continuous Source Current(Diode Conduction)	I _S	-15	A	
Power Dissipation	T _A =25°C	P _D	40	W
	T _A =70°C		20	
Operating Junction Temperature	T _J	-55/150	°C	
Storage Temperature Range	T _{STG}	-55/150	°C	
Thermal Resistance-Junction to Ambient	R _{θJA}	105	°C/W	



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ELECTRICAL CHARACTERISTICS

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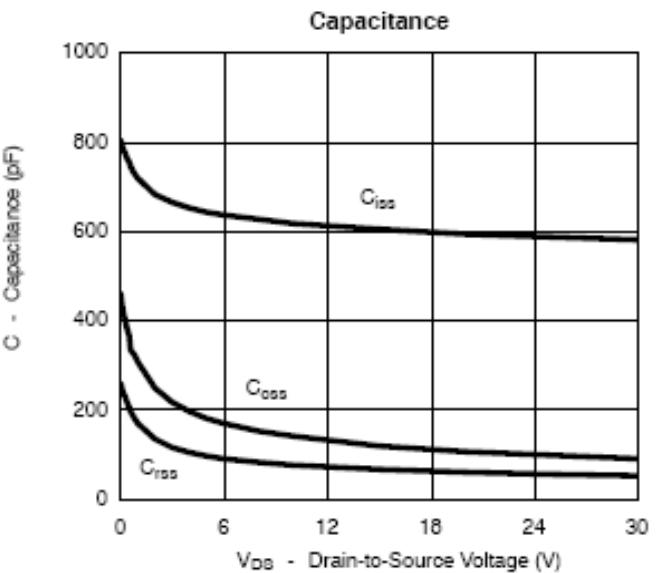
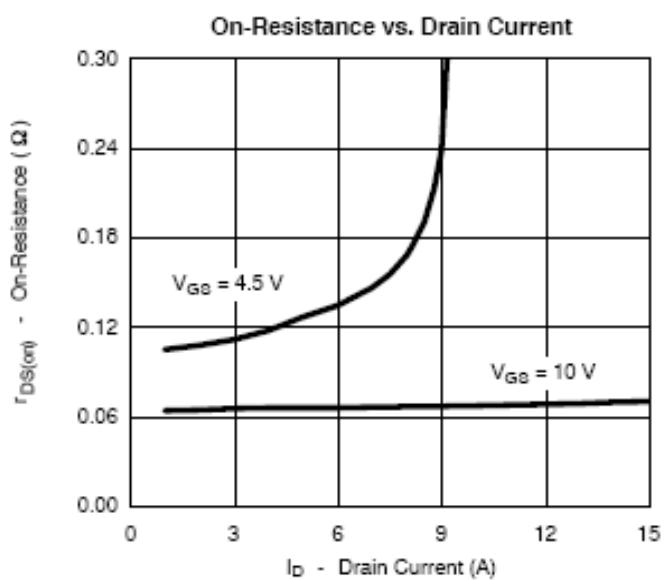
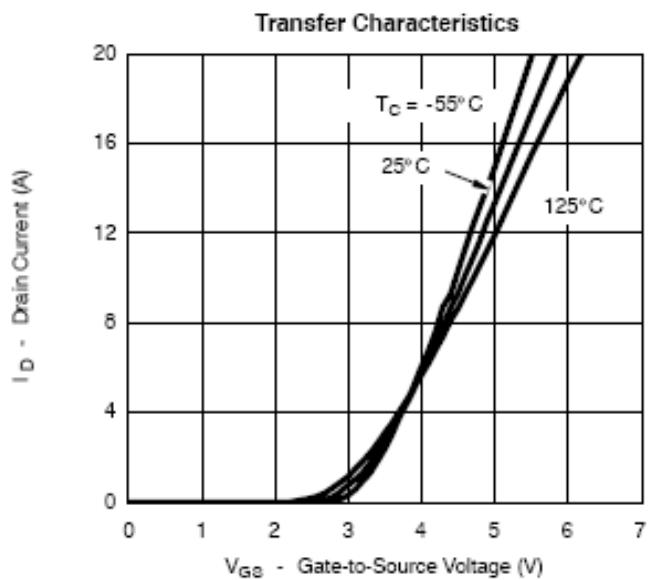
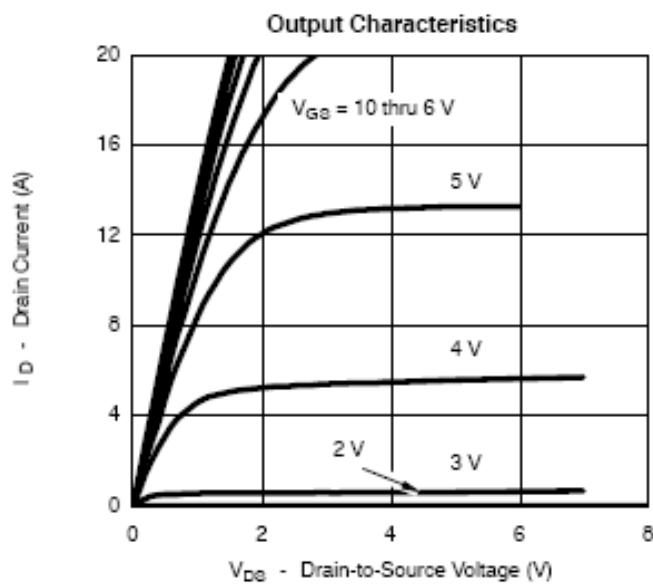
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V, ID=-250uA	-30			V
Gate Threshold Voltage	VGS(th)	VDS=VGS, ID=-250uA	-1.0		-3.0	
Gate Leakage Current	IGSS	VDS=0V, VGS=±20V			±100	nA
Zero Gate Voltage Drain Current	IDSS	VDS=-24V, VGS=0V			-1	uA
		VDS=-24V, VGS=0V TJ=85°C			-5	
Drain-Source On-Resistance	RDS(on)	VGS=-10V, ID=-8A		0.083	0.100	Ω
		VGS=-4.5V, ID=-6A		0.130	0.150	
Forward Transconductance	gfs	VDS=-10V, ID=-8A		8		S
Diode Forward Voltage	VSD	Is=-2.5A, VGS =0V		-0.8	-1.2	V
Dynamic						
Total Gate Charge	Qg	VDS=-15V, VGS=-10V ID=8A		5.8	10	nC
Gate-Source Charge	Qgs			0.8		
Gate-Drain Charge	Qgd			1.5		
Input Capacitance	Ciss	VDS=-15V, VGS=0V f=1MHz		226		pF
Output Capacitance	Coss			87		
Reverse Transfer Capacitance	Crss			19		
Turn-On Time	td(on)	VDD=-15V, RL=15Ω ID=1.0A, VGEN=-10V RG=6Ω		9	20	ns
	tr			9	20	
Turn-Off Time	td(off)			18	35	
	tf			6	20	



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TYPICAL CHARACTERISTICS

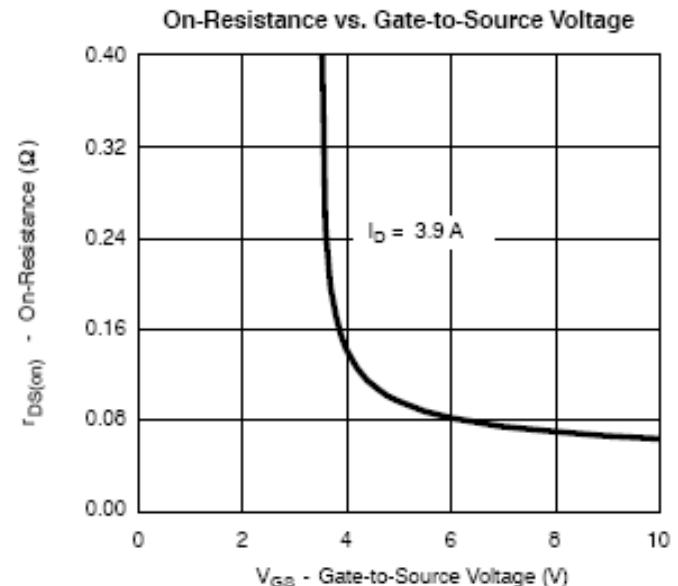
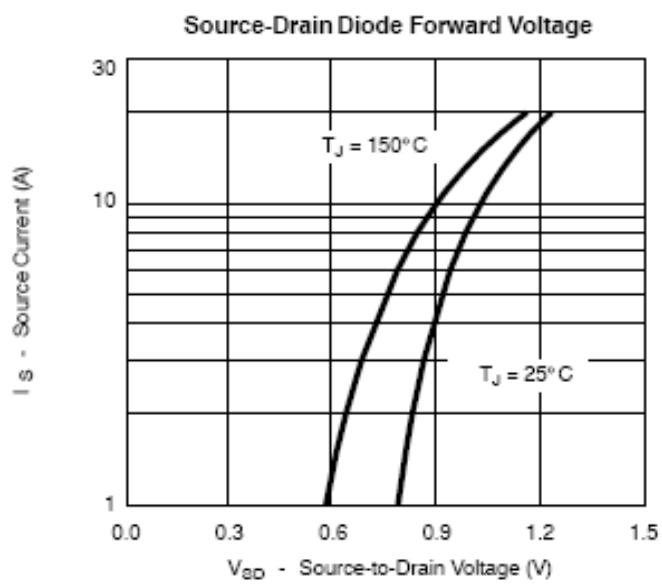
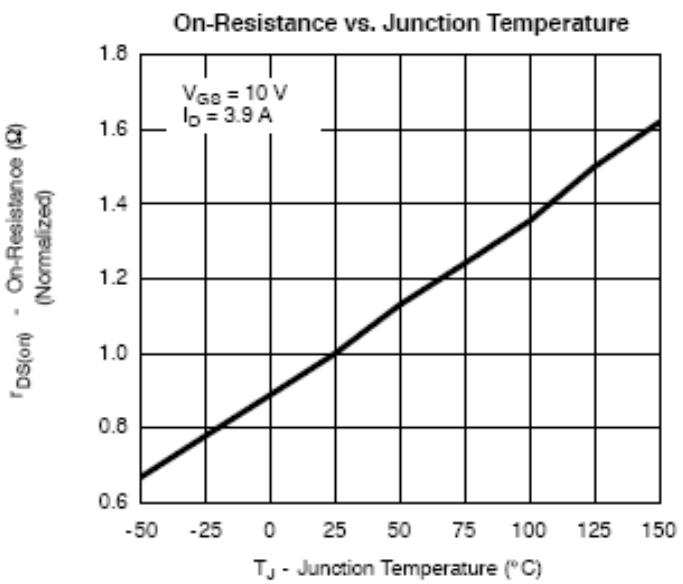
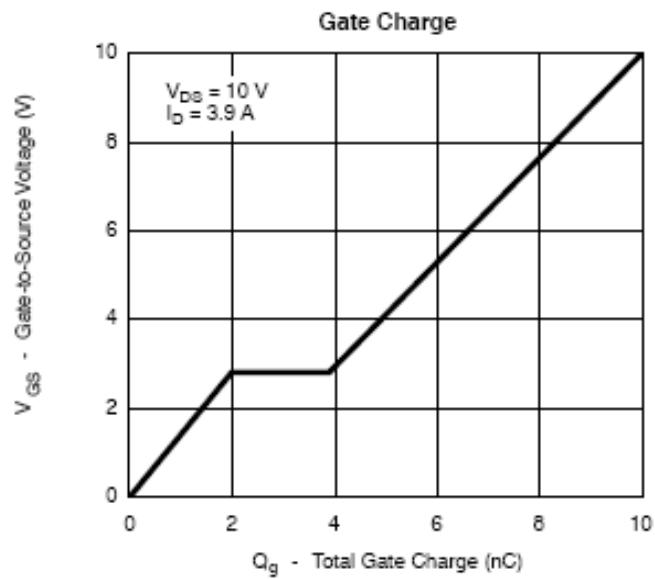




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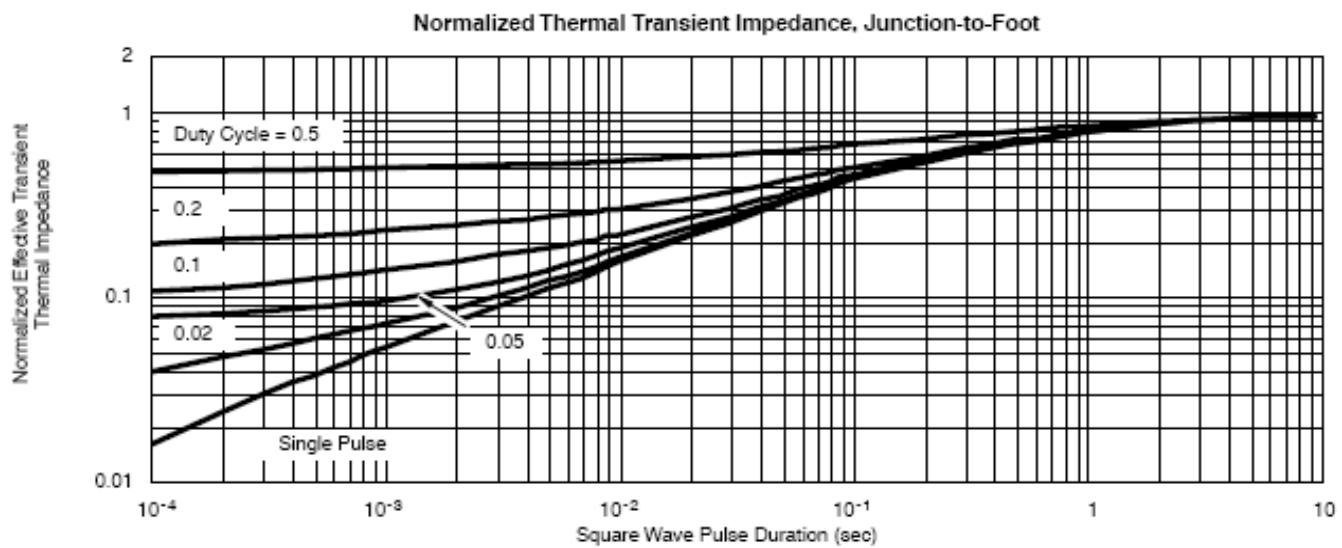
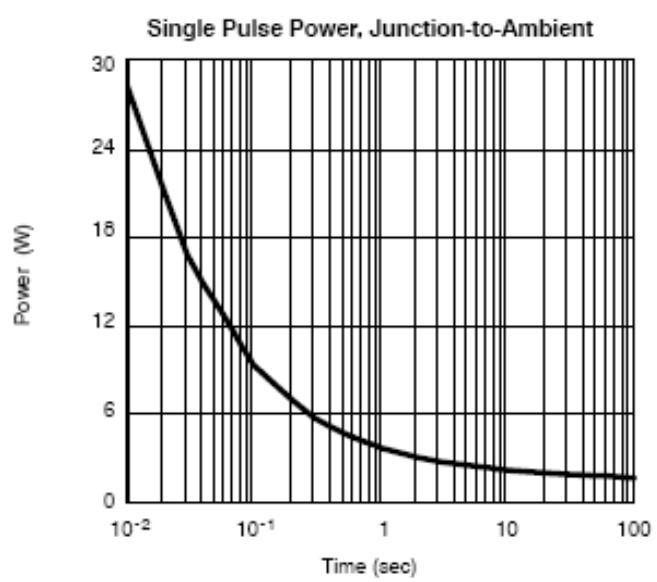
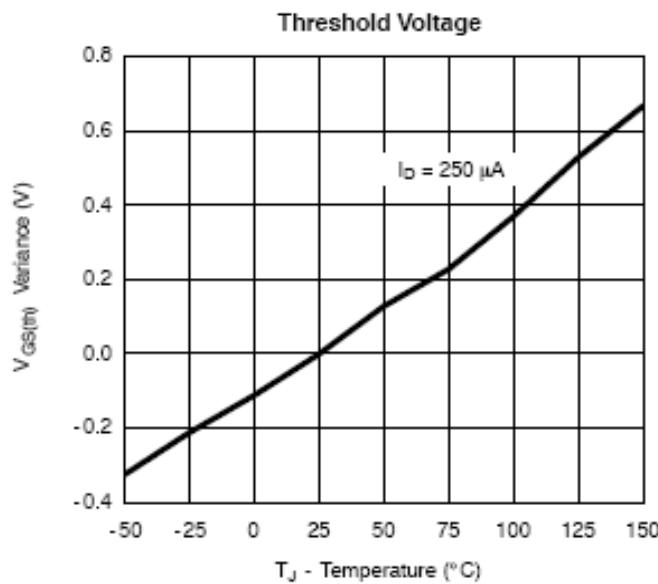




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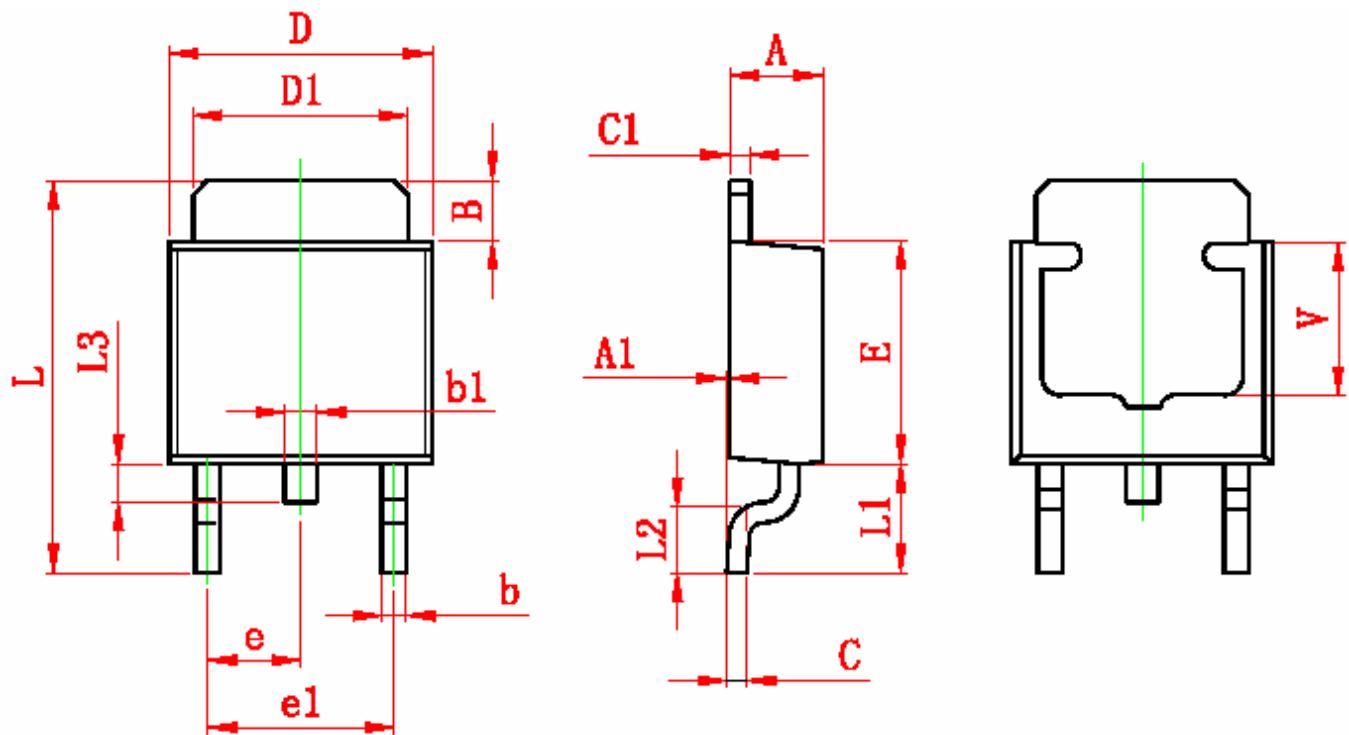




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TO-252-2L PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
B	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	2.300 TYP.		0.091 TYP.	
e1	4.500	4.700	0.177	0.185
L	9.300	9.900	0.366	0.390
L1	2.550	2.900	0.100	0.114
L2	1.400	1.780	0.055	0.070
L3	0.600	0.900	0.024	0.035
V	3.800 REF.		0.150 REF.	



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